

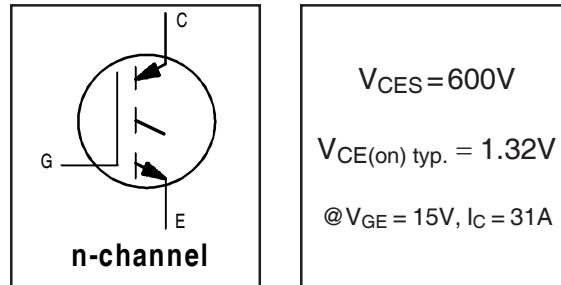
INSULATED GATE BIPOLAR TRANSISTOR

IRG4PC40SPbF

Standard Speed IGBT

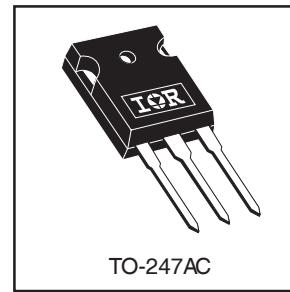
Features

- Standard: Optimized for minimum saturation voltage and low operating frequencies ($< 1\text{kHz}$)
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- Industry standard TO-247AC package
- Lead-Free



Benefits

- Generation 4 IGBT's offer highest efficiency available
- IGBT's optimized for specified application conditions
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBT's



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Breakdown Voltage	600	V
$I_C @ T_C = 25^\circ\text{C}$	Continuous Collector Current	60	
$I_C @ T_C = 100^\circ\text{C}$	Continuous Collector Current	31	A
I_{CM}	Pulsed Collector Current ①	120	
I_{LM}	Clamped Inductive Load Current ②	120	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
E_{ARV}	Reverse Voltage Avalanche Energy ③	15	mJ
$P_D @ T_C = 25^\circ\text{C}$	Maximum Power Dissipation	160	W
$P_D @ T_C = 100^\circ\text{C}$	Maximum Power Dissipation	65	
T_J	Operating Junction and	-55 to + 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm from case))	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	0.77	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.24	—	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	40	
Wt	Weight	6 (0.21)	—	g (oz)

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International
Rectifier

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage	600	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 250\mu\text{A}$
$V_{(\text{BR})\text{ECS}}$	Emitter-to-Collector Breakdown Voltage ④	18	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.75	—	V°C	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{ON})}$	Collector-to-Emitter Saturation Voltage	—	1.32	1.5	V	$I_C = 31\text{A}$
		—	1.68	—		$I_C = 60\text{A}$
		—	1.32	—		$I_C = 31\text{A}, T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-9.3	—	mV°C	$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
g_f	Forward Transconductance ⑤	12	21	—	S	$V_{\text{CE}} = 100\text{V}, I_C = 31\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 600\text{V}$
		—	—	2.0		$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 10\text{V}, T_J = 25^\circ\text{C}$
		—	—	1000		$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 600\text{V}, T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	100	150	nC	$I_C = 31\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	14	21		$V_{\text{CC}} = 400\text{V}$
Q_{gc}	Gate - Collector Charge (turn-on)	—	34	51		See Fig. 8 $V_{\text{GE}} = 15\text{V}$
$t_{d(\text{on})}$	Turn-On Delay Time	—	22	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 31\text{A}, V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}, R_G = 10\Omega$
t_r	Rise Time	—	18	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	650	980		
t_f	Fall Time	—	380	570	mJ	Energy losses include "tail" See Fig. 10, 11, 13, 14
E_{on}	Turn-On Switching Loss	—	0.45	—		
E_{off}	Turn-Off Switching Loss	—	6.5	—		
E_{ts}	Total Switching Loss	—	6.95	9.9		
$t_{d(\text{on})}$	Turn-On Delay Time	—	23	—	ns	$T_J = 150^\circ\text{C},$ $I_C = 31\text{A}, V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}, R_G = 10\Omega$
t_r	Rise Time	—	21	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	1000	—		
t_f	Fall Time	—	940	—	mJ	Energy losses include "tail" See Fig. 13, 14
E_{ts}	Total Switching Loss	—	12	—		
L_E	Internal Emitter Inductance	—	13	—	nH	Measured 5mm from package
C_{ies}	Input Capacitance	—	2200	—	pF	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$
C_{oes}	Output Capacitance	—	140	—		
C_{res}	Reverse Transfer Capacitance	—	26	—		

Notes:

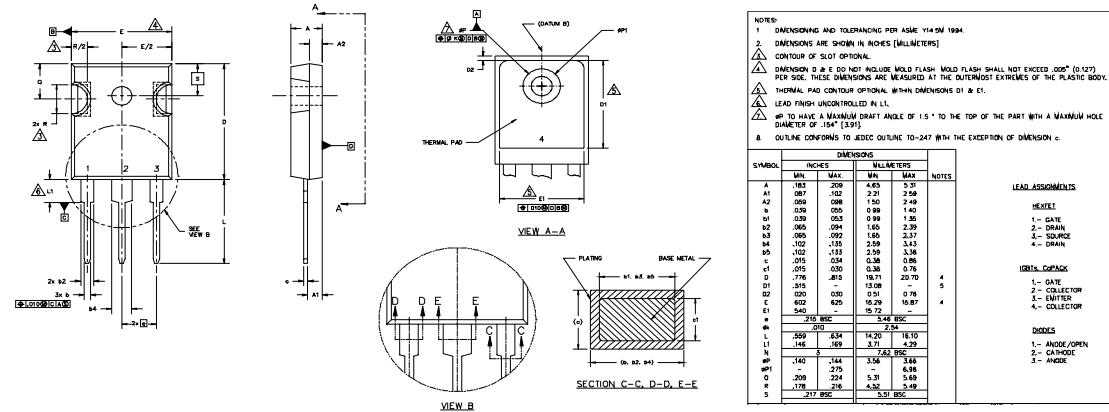
- ① Repetitive rating; $V_{\text{GE}} = 20\text{V}$, pulse width limited by max. junction temperature. (See fig. 13b)
- ② $V_{\text{CC}} = 80\%(V_{\text{CES}})$, $V_{\text{GE}} = 20\text{V}$, $L = 10\mu\text{H}$, $R_G = 10\Omega$, (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width $\leq 80\mu\text{s}$; duty factor $\leq 0.1\%$.
- ⑤ Pulse width $5.0\mu\text{s}$, single shot.

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TO-247AC Package Outline

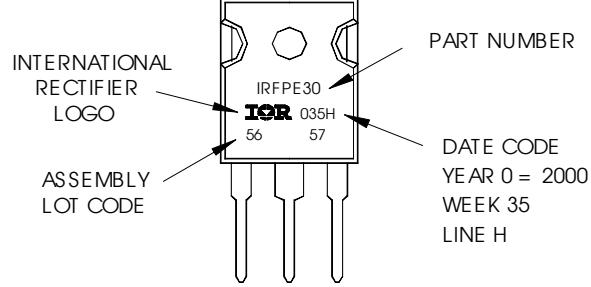
Dimensions are shown in millimeters (inches)



TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30
WITH ASSEMBLY
LOT CODE 5657
ASSEMBLED ON WW 35, 2000
IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line
position indicates "Lead-Free"



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